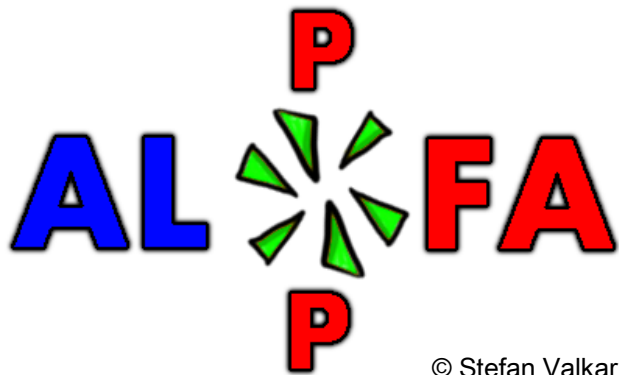


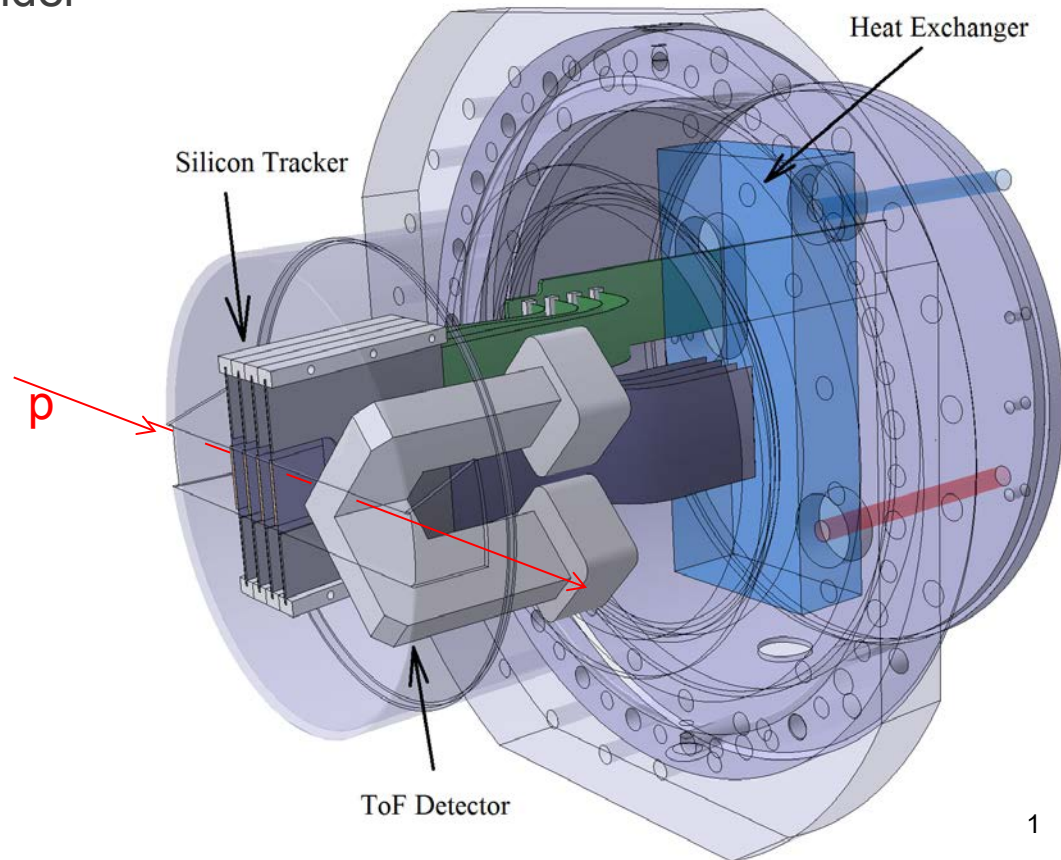
# AFP BLM

Michael Rijssenbeek

- Draft Design of the SiT Card
- Draft Design of the SiT Holder



© Stefan Valkar



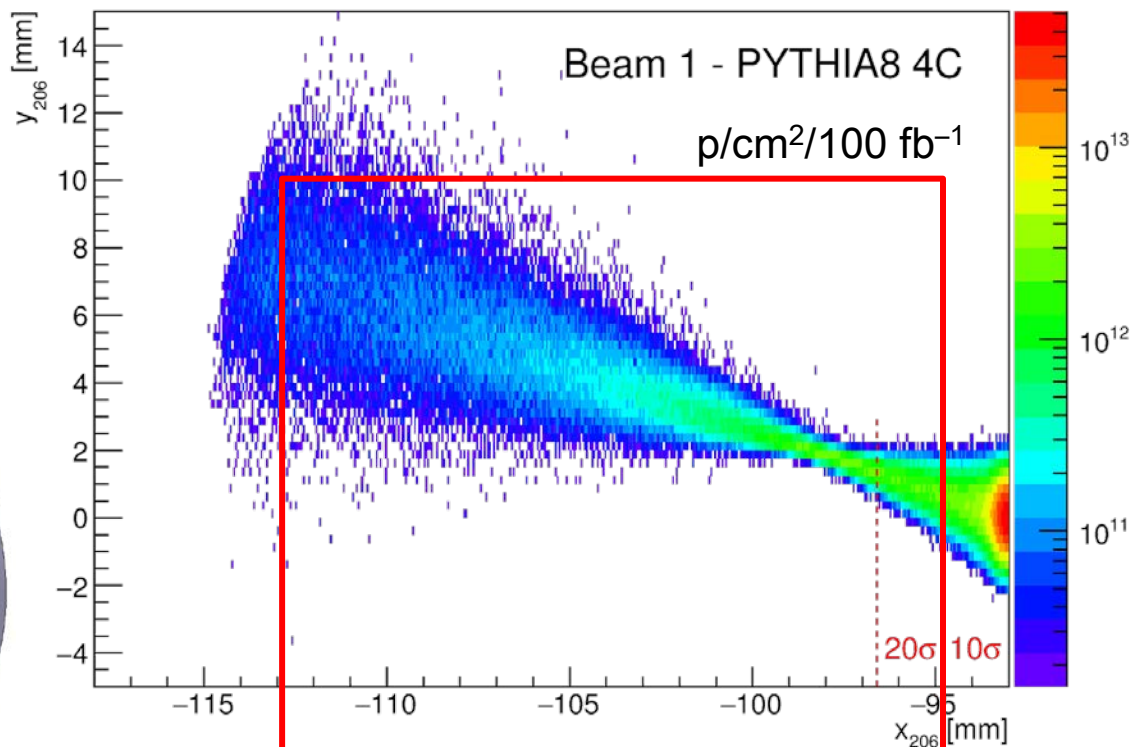
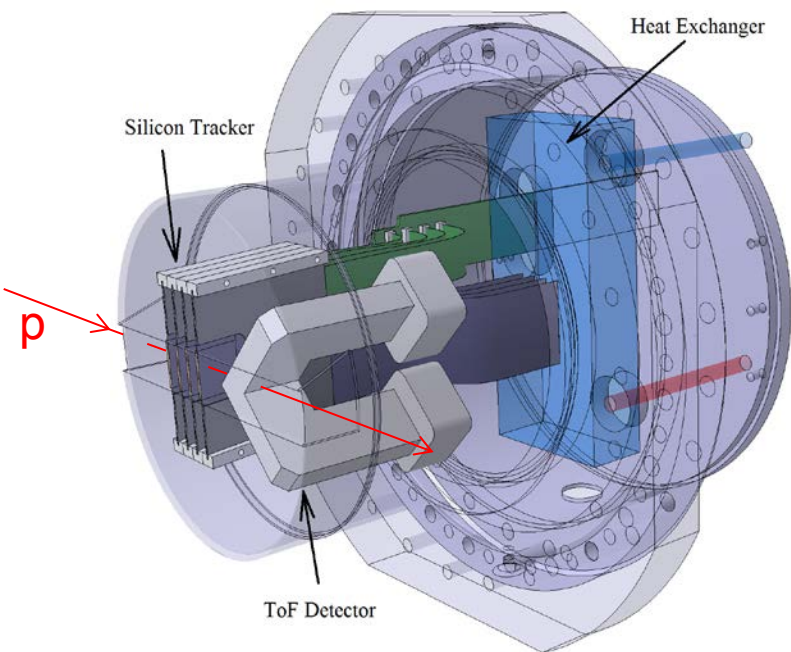
# ATLAS Forward Protons at 206 m



Hit pattern in AFP is determined by the LHC optics

For  $\beta^*=0.55$  m:

- upward tilt for protons with energy loss is caused by vertical crossing angle in Point 1



3D Si sensor @  $10\sigma$

# Approval History



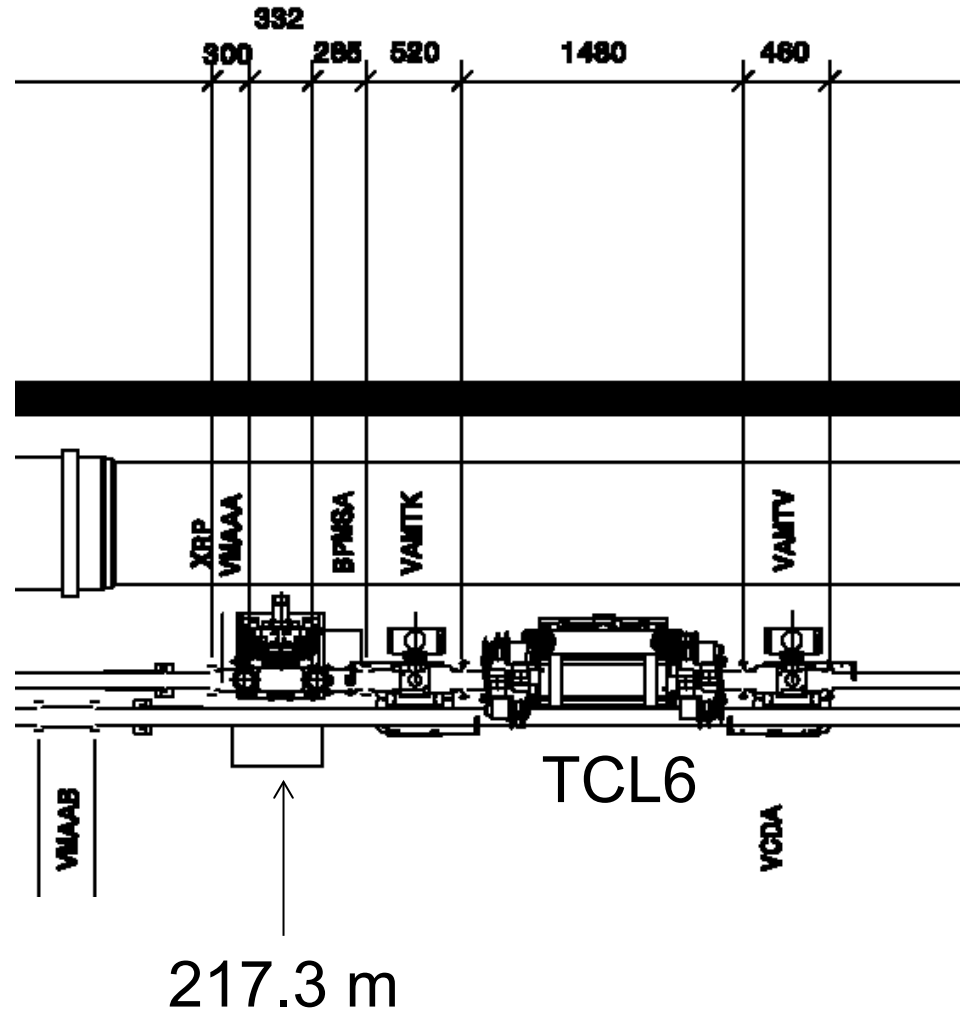
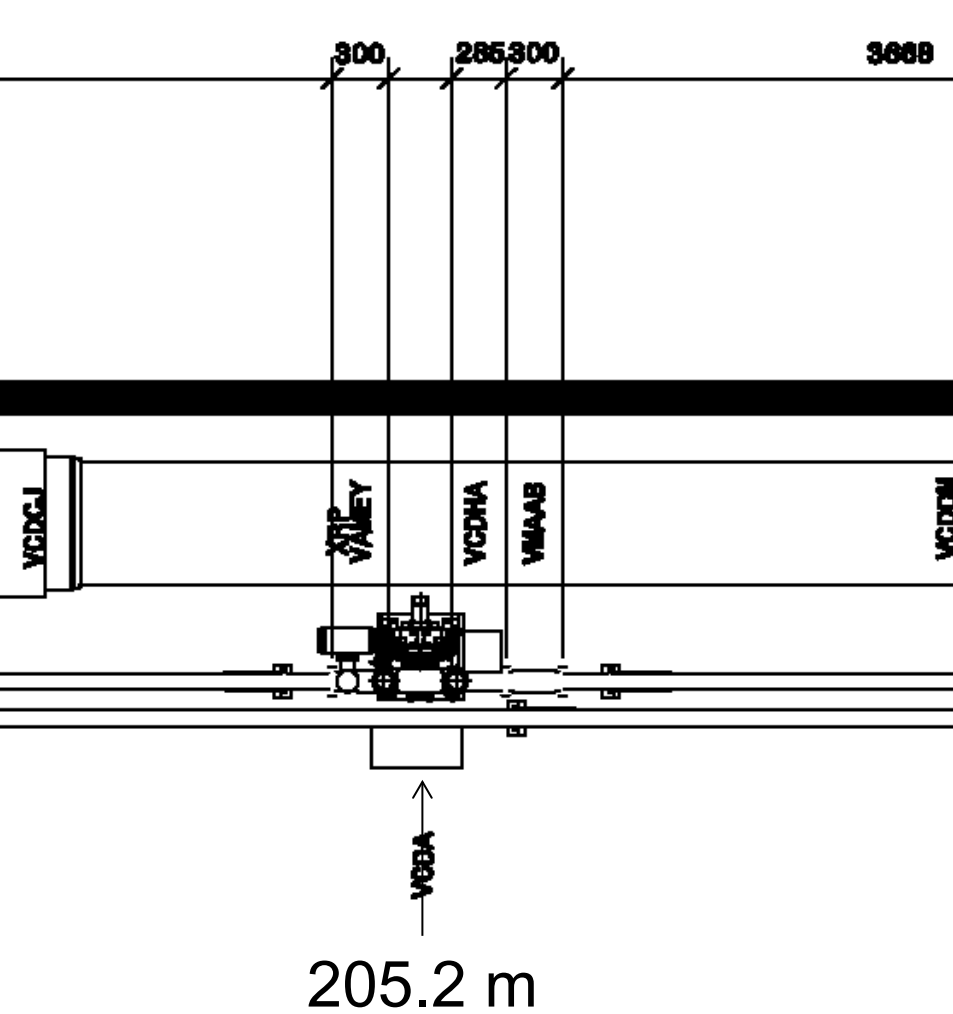
## AFP TDR:

The ATLAS Collaboration , "Technical Design Report for the ATLAS Forward Proton Detector", CERN-LHCC-2015-009 ; ATLAS-TDR-024; url: <https://cds.cern.ch/record/2017378/>

## Engineering Change Request:

second review of vs. 0.3 closed on Aug 7 ...  
Accepted at LMC meeting Aug 26



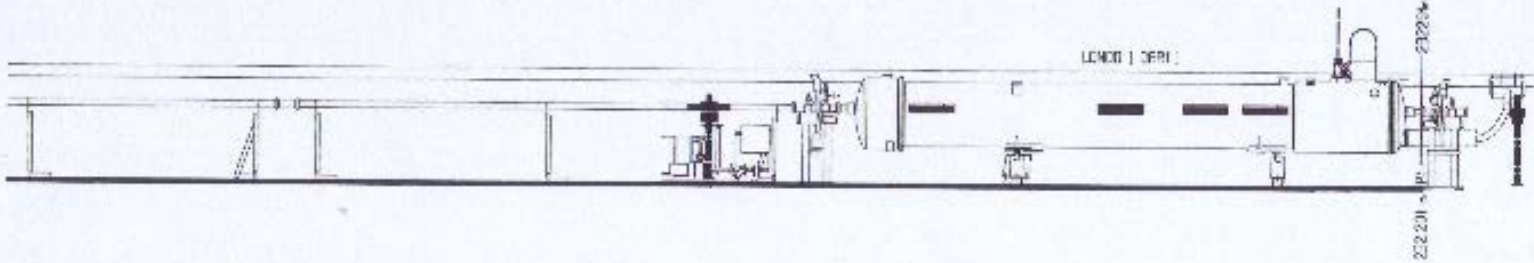




16/02/2015

HC 070 HC 070

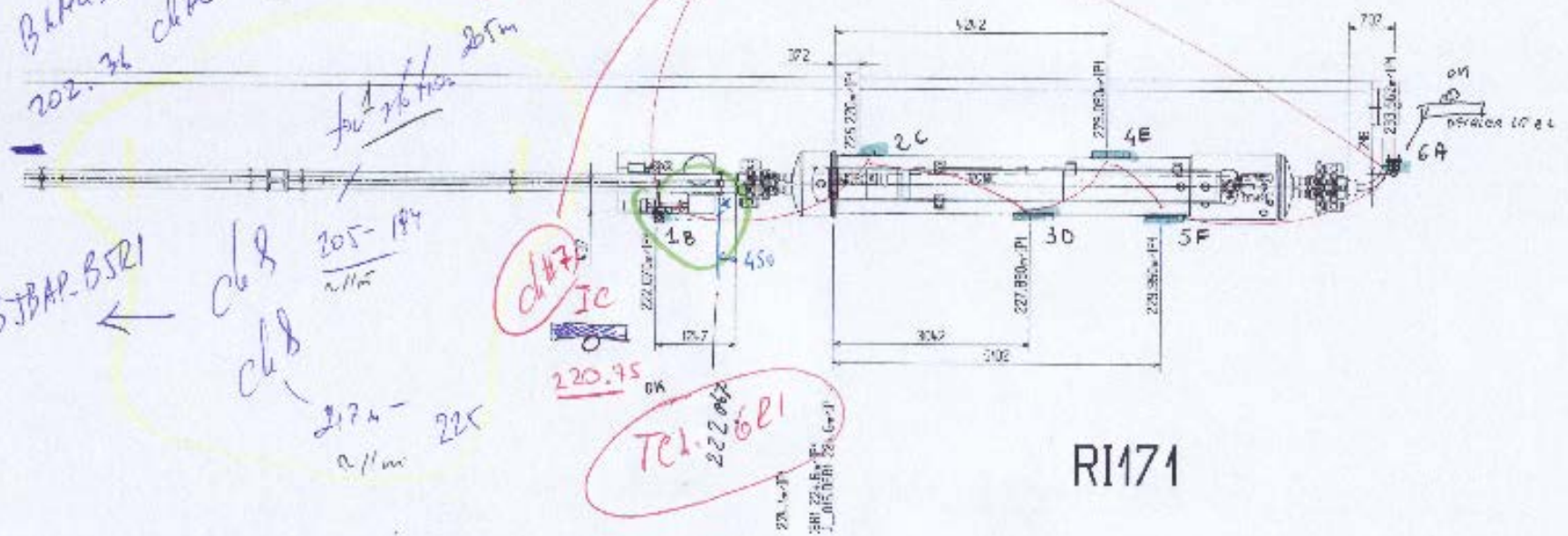
CGR1



CSRI  
 BJBAP, BSRI  
 B.M.H. ABB  
 202.36 cl#6  
 cl#2!

YRP

A6



RI171

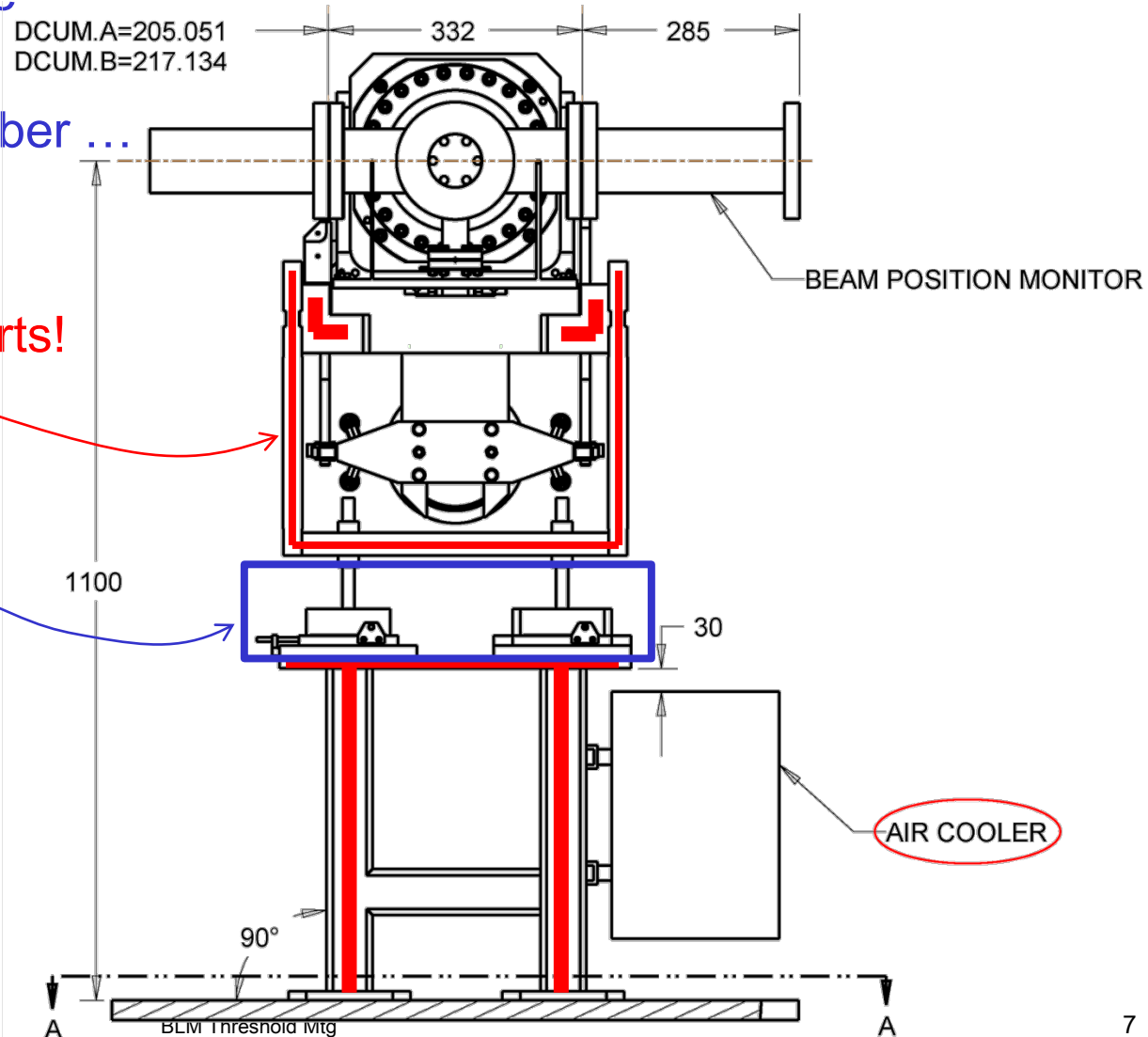
# Roman Pot Stations

Vakuüm Praha started

- close contact in Prague
  - Vit Vorobel will assist
- MR will visit in September ...

Michel Raymond's shop produced **two XRP supports!**

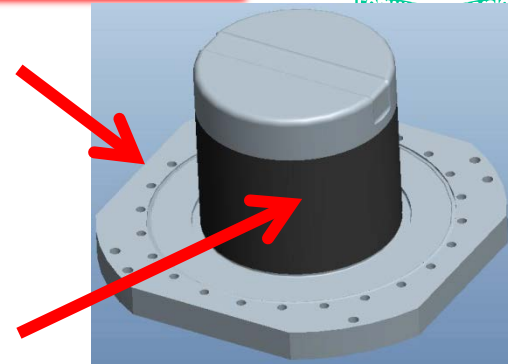
- delivered to SR1
- we still need:
  - the adjustable feet !
  - all the nuts & bolts



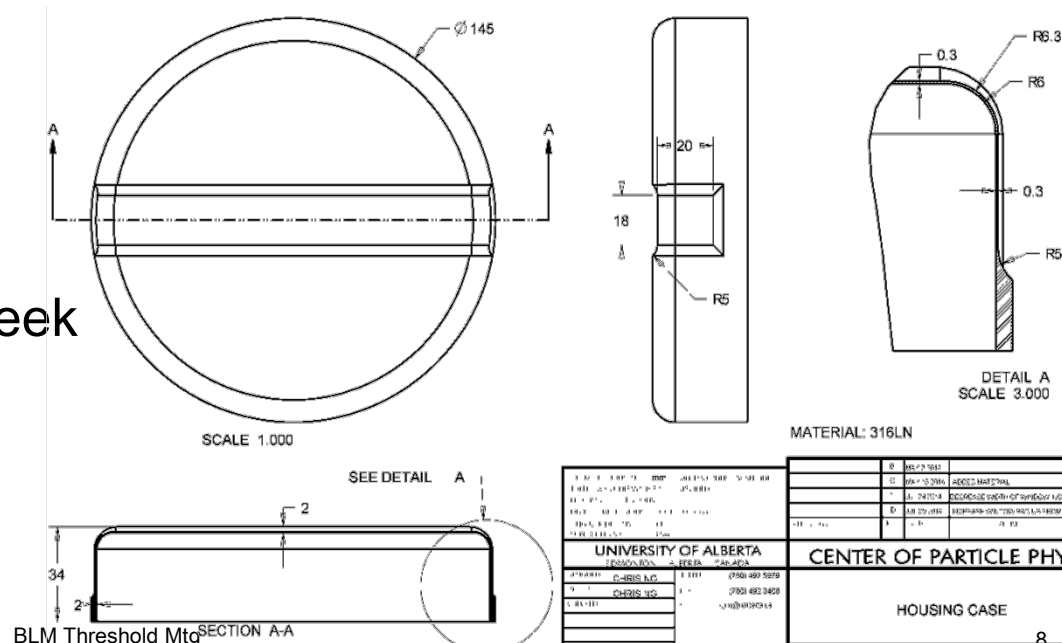
# Roman Pot



- Have 2 pc 316LN rough flange (295 mm OD)
  - arrived at Alberta on June 26
  - machined
- Have 2 pc 316LN cylinders manufactured into “tubes”
  - manufactured tube at CERN (Chris Ng)
    - ID 141 mm, OD 145 mm, 83 mm long (0.7 kg)
  - ordered 4 pc more ...



- 6 pc 3D Forged 316LN for pot bottom
- First pot back at CERN next week





# Choice of Card material

- Requirements:
  - Need good thermal conductivity, do NOT need electrical circuitry
  - Need minimal interaction & radiation length
  - Stiff and precise
- Good heat conduction:
  - Conductivity PGS ~ Cu (in practice), Cu ~ 2x Al, Carbon-Fiber
  - Thus: Cu (+C-based substrate), or Al (+C-based substrate),
- Long Interaction length, X0:
  - PGS (+ C-based substrate), Al, Cu (2.5 times worse than Al)
- Stiffness, Precision:
  - PCB: OK, Al: OK

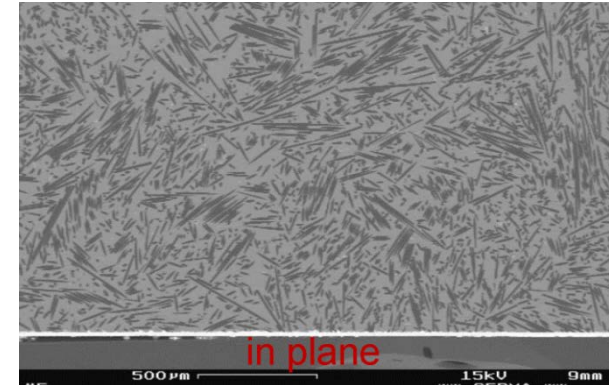
Fall-back: Al, 1mm,  
with local thinning to 0.3 mm

| Material     | Thickness<br>(cm) | $\theta_0$<br>( $\mu$ rad) | $P_{\text{Coil}}$<br>(%) | $P_{\text{Int}}$<br>(%) |
|--------------|-------------------|----------------------------|--------------------------|-------------------------|
| Be           | 0.03              | 0.041461597                | 0.10%                    | 0.07%                   |
| Al           | 0.03              | 0.088421083                | 0.12%                    | 0.08%                   |
| Inconel 718R | 0.02              | 0.184210737                | 0.19%                    | 0.12%                   |
| SS 316L      | 0.03              | 0.217801393                | 0.29%                    | 0.18%                   |
| Ti           | 0.02              | 0.116958447                | 0.12%                    | 0.07%                   |
| Si           | 0.095             | 0.161507946                | 0.30%                    | 0.20%                   |
| Cu           | 0.015             | 0.164194035                | 0.16%                    | 0.10%                   |
| Kapton       | 0.085             | 0.068076487                | 0.14%                    | 0.10%                   |

# Better Card Material

**NOVAPACK:** Carbon fibers embedded in Al matrix (4ppm: Cf 45% by mass)

- Excellent thermal conductivity (in plane)
- Low expansion coefficient
- Low density
- stiffer than Al



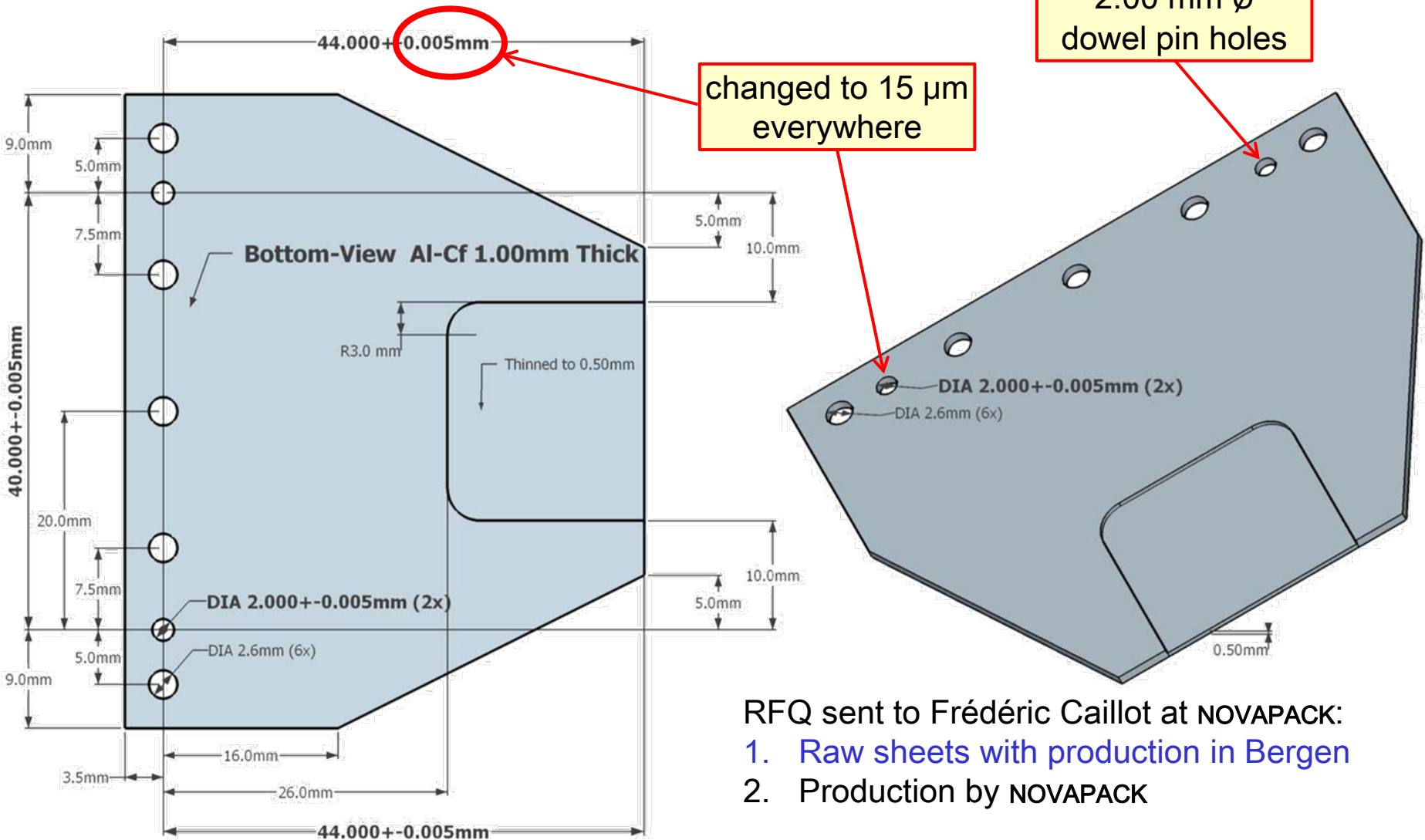
Proposed by  
Sebastien  
Michal

— possibly  
used in iTK

| PROPERTIES                           | - 7  | - 4 |
|--------------------------------------|------|-----|
| <b><i>Thermal properties</i></b>     |      |     |
| Thermal conductivity (W/m.K) / (X-Y) | 200  | 230 |
| Thermal conductivity (W/m.K) / (Z)   | 125  | 120 |
| Specific Heat Capacity (J/kg.K)      | 880  | 850 |
| <b><i>Physical properties</i></b>    |      |     |
| CTE 25 - 150°C (ppm/°C) / (X-Y)      | 7    | 4   |
| CTE 25 - 150°C (ppm/°C) / (Z)        | 24   | 24  |
| Density (g/cm <sup>3</sup> )         | 2.46 | 2.4 |
| <b><i>Mechanical properties</i></b>  |      |     |
| Young's modulus (GPa)                | 90   | 98  |
| Flexural Strength (MPa)              | 160  | 185 |
| <b><i>Electrical properties</i></b>  |      |     |
| Electrical resistivity (μohm.cm)     | 6.9  |     |

# SiT Layer Card

- Card from Al-Carbon-Fibre (NOVAPACK)



- RFQ sent to Frédéric Caillot at NOVAPACK:
- Raw sheets with production in Bergen
  - Production by NOVAPACK

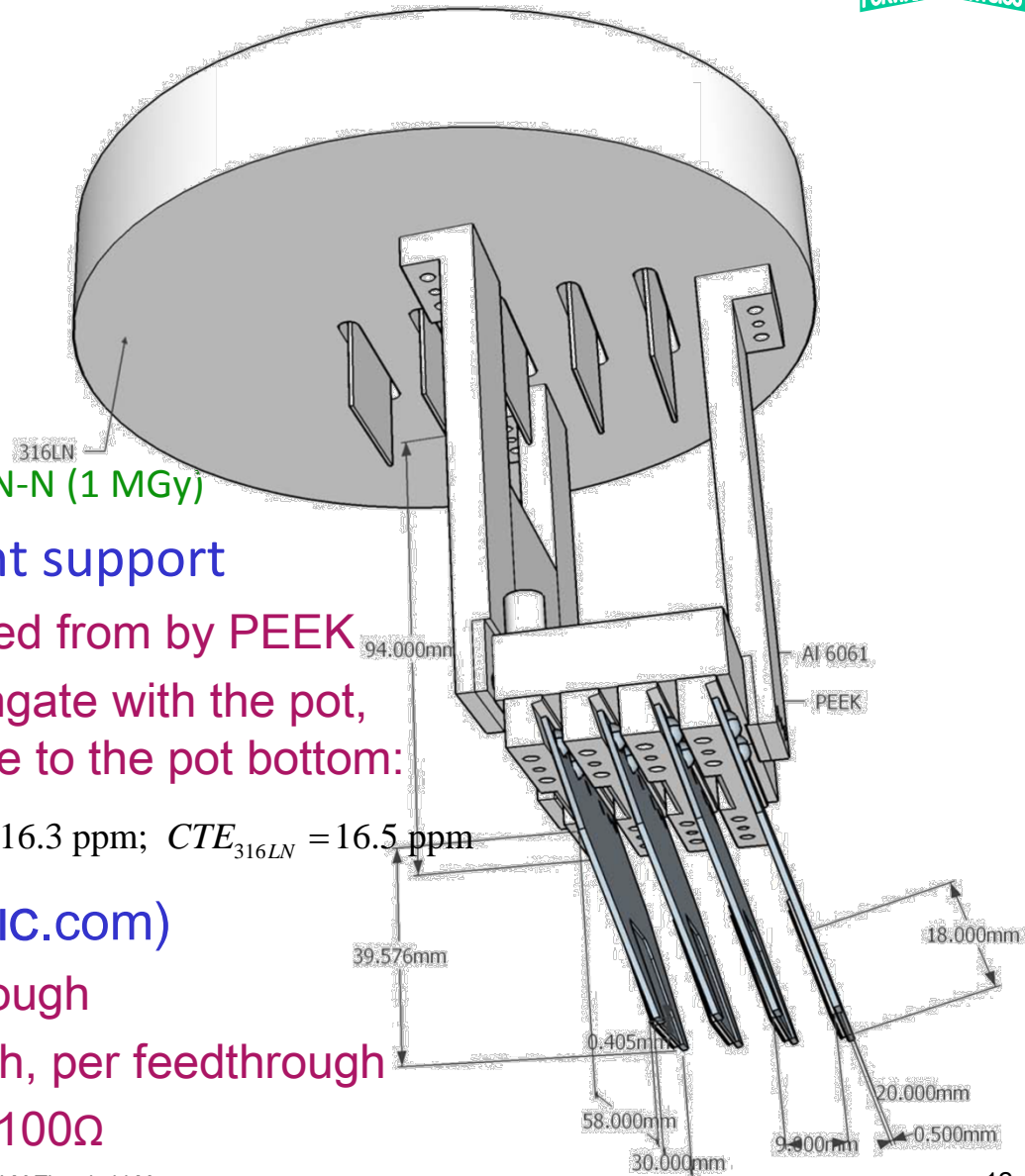
# Holder (Draft Design)

Most material (except layer cards) outside the beam aperture (40 mm)

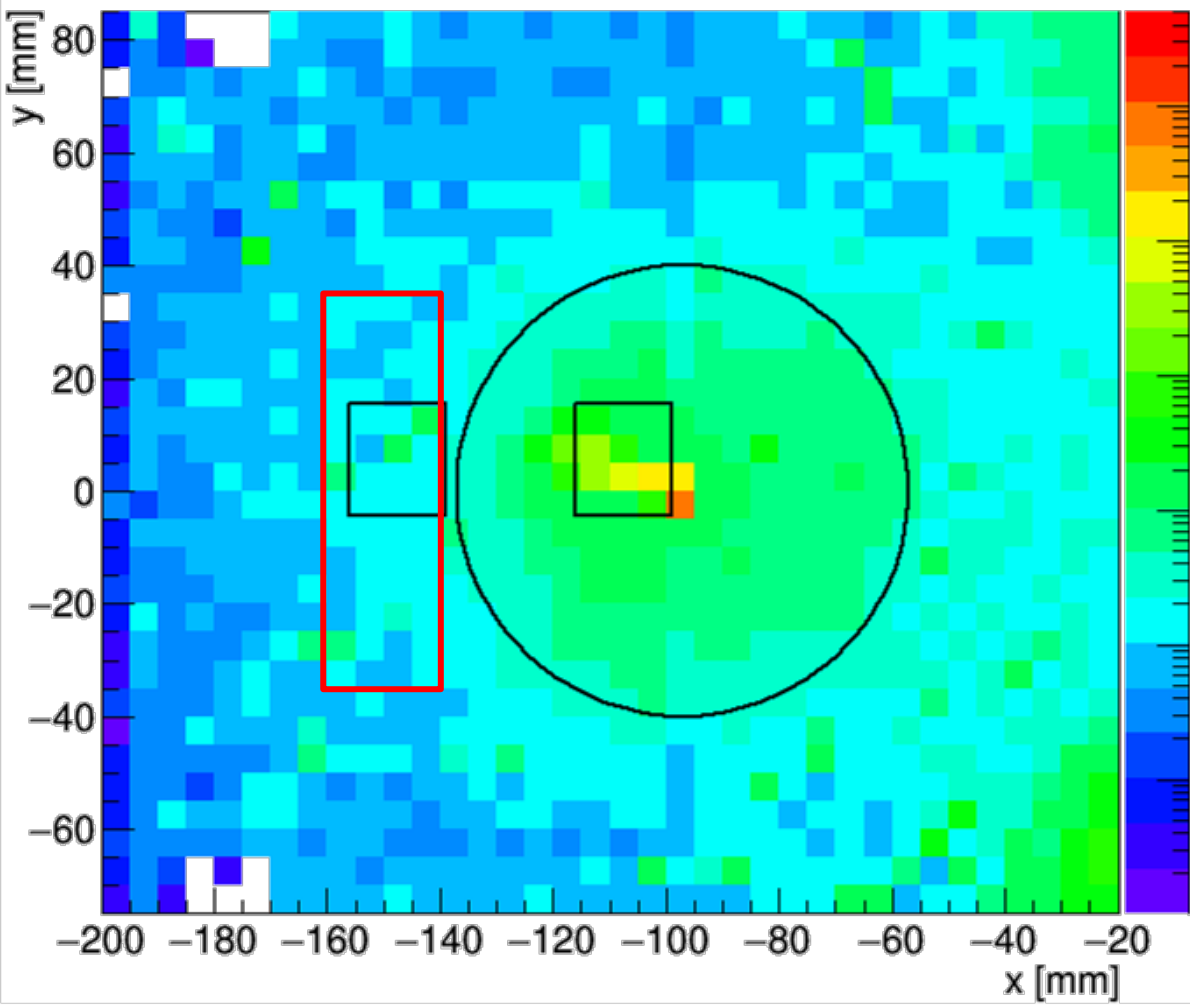
- Alu Tilt bars:
  - hold the cards at  $\sim 14^\circ$
  - thermal coupling between card and Al Heat-Exchanger
    - thermal vacuum grease APIEZON-N (1 MGy)
- Al (6061) pillars provide 3-point support
  - thermally/electrically de-coupled from by PEEK
  - same T as pot/flange; will elongate with the pot, and maintain constant distance to the pot bottom:

$$CTE_{Holder} = \frac{93 \text{ mm}}{134 \text{ mm}} CTE_{Al} = \frac{93 \text{ mm}}{134 \text{ mm}} 23.6 \text{ ppm} = 16.3 \text{ ppm}; \quad CTE_{316LN} = 16.5 \text{ ppm}$$

- Feedthroughs: ([www.NICOMATIC.com](http://www.NICOMATIC.com))
  - vacuum flat flex cable feedthrough
  - e.g. 50 strip lines, 0.5 mm pitch, per feedthrough
  - impedance options  $50\Omega$ ,  $75\Omega$ ,  $100\Omega$



# Interaction Length of the Holder



- Detector (black):
  - $\sim 10^{14} \text{ neq/cm}^2$
  - Area  $100 \text{ mm}^2$
  - $\lambda_{\text{int}} = 1\%$
- Holder (red outline)
  - $\sim 1 \times 10^{11} \text{ neq/cm}^2$
  - note: statistics is poor ...
  - Area  $1400 \text{ mm}^2$
  - eff depth  $\sim 25 \text{ mm}$
  - $\lambda_{\text{int}} = 6\%$

• relative interaction rate expected from frame compared to sensors:

$$\frac{1 \times 10^{11}}{1 \times 10^{14}} \frac{1400 \text{ mm}^2}{100 \text{ mm}^2} \frac{6\%}{1\%} \approx 10\%$$

# Back-up





## FFCs:

- Nicomatic + Hirose ZIF connectors
- Molex
- JAE, 20-100 cm long, 0.5, 1 mm pitch,  $Z_0=100$  Ohm, price ~\$10 @digikey, conns \$2 @digikey